



Welcome to **E-XFL.COM**

Understanding <u>Embedded - FPGAs (Field Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

| Details | |
|--------------------------------|---|
| Product Status | Obsolete |
| Number of LABs/CLBs | - |
| Number of Logic Elements/Cells | 1024 |
| Total RAM Bits | - |
| Number of I/O | 95 |
| Number of Gates | 6000 |
| Voltage - Supply | 4.5V ~ 5.5V |
| Mounting Type | Surface Mount |
| Operating Temperature | -40°C ~ 85°C (TC) |
| Package / Case | 144-LQFP |
| Supplier Device Package | 144-LQFP (20x20) |
| Purchase URL | https://www.e-xfl.com/product-detail/microchip-technology/at6002a-2ai |

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

Figure 2. Busing Network (one sector)

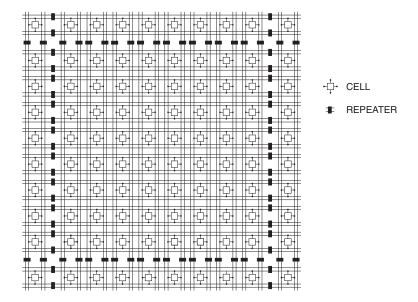
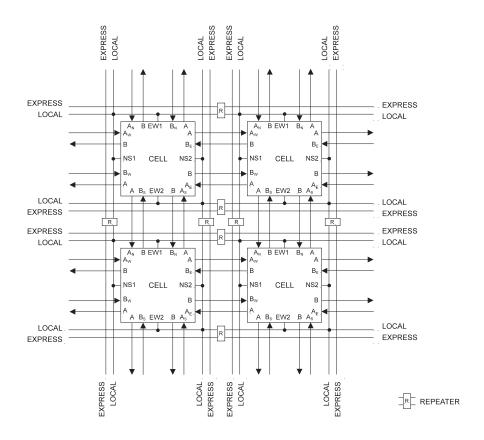


Figure 3. Cell-to-cell and Bus-to-bus Connections





Each cell, in addition, provides the ability to route a signal on a 90° turn between the NS1 bus and EW1 bus and between the NS2 bus and EW2 bus.

Express buses are not connected directly to cells, and thus provide higher speeds. They are the fastest way to cover long, straight-line distances within the array.

Each express bus is paired with a local bus, so there are two express buses for every column and two express buses for every row of cells.

Connective units, called repeaters, spaced every eight cells, divide each bus, both local and express, into segments spanning eight cells. Repeaters are aligned in rows and columns thereby partitioning the array into 8 x 8 sectors of cells. Each repeater is associated with a local/express pair, and on each side of the repeater are connections to a local-bus segment and an express-bus segment. The repeater can be programmed to provide any one of twenty-one connecting functions. These functions are symmetric with respect to both the two repeater sides and the two types of buses.

Among the functions provided are the ability to:

- Isolate bus segments from one another
- · Connect two local-bus segments
- Connect two express-bus segments
- Implement a local/express transfer

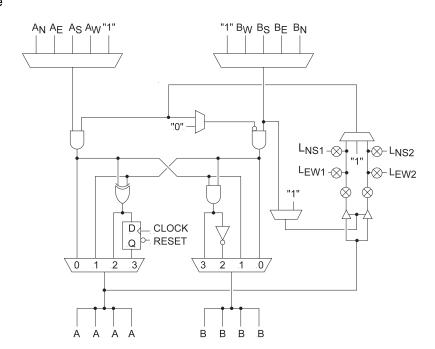
In all of these cases, each connection provides signal regeneration and is thus unidirectional. For bidirectional connections, the basic repeater function for the NS2 and EW2 repeaters is augmented with a special programmable connection allowing bidirectional communication between local-bus segments. This option is primarily used to implement long, tristate buses.

The Cell Structure

The Atmel cell (Figure 4) is simple and small and yet can be programmed to perform all the logic and wiring functions needed to implement any digital circuit. Its four sides are functionally identical, so each cell is completely symmetrical.

Read/write access to the four local buses – NS1, EW1, NS2 and EW2 – is controlled, in part, by four bidirectional pass gates connected directly to the buses. To read a local bus, the pass gate for that bus is turned on and the three-input multiplexer is set accordingly. To write to a local bus, the pass gate for that bus and the pass gate for the associated tristate driver are both turned on. The two-input multiplexer supplying the control signal to the drivers permits either: (1) active drive, or (2) dynamic tristating controlled by the B input. Turning between $L_{\rm NS1}$ and $L_{\rm EW1}$ or between $L_{\rm NS2}$ and $L_{\rm EW2}$ is accomplished by turning on the two associated pass gates. The operations of reading, writing and turning are subject to the restriction that each bus can be involved in no more than a **single** operation.

Figure 4. Cell Structure



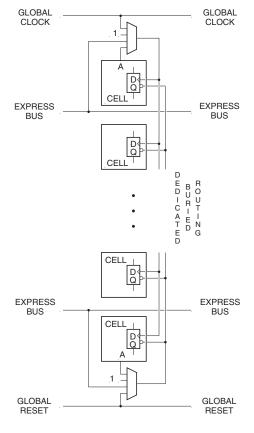
Clock Distribution

Along the top edge of the array is logic for distributing clock signals to the D flip-flop in each logic cell (Figure 10). The distribution network is organized by column and permits columns of cells to be independently clocked. At the head of each column is a user-configurable multiplexer providing the clock signal for that column. It has four inputs:

- Global clock supplied through the CLOCK pin
- Express bus adjacent to the distribution logic
- "A" output of the cell at the head of the column
- Logical constant "1" to conserve power (no clock)

Through the global clock, the network provides low-skew distribution of an externally supplied clock to any or all of the columns of the array. The global clock pin is also connected directly to the array via the A input of the upper left and right corner cells (AW on the left, and AN on the right). The express bus is useful in distributing a secondary clock to multiple columns when the global clock line is used as a primary clock. The A output of a cell is useful in providing a clock signal to a single column. The constant "1" is used to reduce power dissipation in columns using no registers.

Figure 10. Column Clock and Column Reset



Asynchronous Reset

Along the bottom edge of the array is logic for asynchronously resetting the D flip-flops in the logic cells (Figure 10). Like the clock network, the asynchronous reset network is organized by column and permits columns to be independently reset. At the bottom of each column is a user-configurable multiplexer providing the reset signal for that column. It has four inputs:

- Global asynchronous reset supplied through the RESET pin
- · Express bus adjacent to the distribution logic
- · "A" output of the cell at the foot of the column
- Logical constant "1" to conserve power

The asynchronous reset logic uses these four inputs in the same way that the clock distribution logic does. Through the global asynchronous reset, any or all columns can be reset by an externally supplied signal. The global asynchronous reset pin is also connected directly to the array via the A input of the lower left and right corner cells (AS on the left, and AE on the right). The express bus can be used to distribute a secondary reset to multiple columns when the global reset line is used as a primary reset, the A output of a cell can also provide an asynchronous reset signal to a single column, and the constant "1" is used by columns with registers requiring no reset. All registers are reset during power-up.

Input/Output

The Atmel architecture provides a flexible interface between the logic array, the configuration control logic and the I/O pins.

Two adjacent cells – an "exit" and an "entrance" cell – on the perimeter of the logic array are associated with each I/O pin.

There are two types of I/Os: A-type (Figure 11) and B-type (Figure 12). For A-type I/Os, the edge-facing A output of an exit cell is connected to an output driver, and the edge-facing A input of the adjacent entrance cell is connected to an input buffer. The output of the output driver and the input of the input buffer are connected to a common pin.

B-type I/Os are the same as A-type I/Os, but use the B inputs and outputs of their respective entrance and exit cells. A- and B-type I/Os alternate around the array Control of the I/O logic is provided by user-configurable memory bits.





Figure 11. A-type I/O Logic

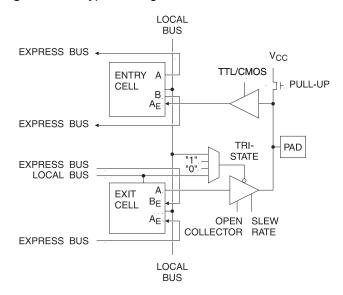
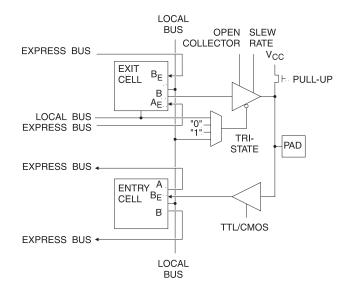


Figure 12. B-type I/O Logic



TTL/CMOS Inputs

A user-configurable bit determines the threshold level – TTL or CMOS – of the input buffer.

Open Collector/Tristate Outputs

A user-configurable bit which enables or disables the active pull-up of the output device.

Slew Rate Control

A user-configurable bit controls the slew rate – fast or slow – of the output buffer. A slow slew rate, which reduces noise and ground bounce, is recommended for outputs that are not speed-critical. Fast and slow slew rates have the same DC-current sinking capabilities, but the rate at which each allows the output devices to reach full drive differs.

Pull-up

A user-configurable bit controls the pull-up transistor in the I/O pin. It's primary function is to provide a logical "1" to unused input pins. When on, it is approximately equivalent to a 25K resistor to $V_{\rm CC}$.

Enable Select

User-configurable bits determine the output-enable for the output driver. The output driver can be static – always on or always off – or dynamically controlled by a signal generated in the array. Four options are available from the array: (1) the control is low and always driving; (2) the control is high and never driving; (3) the control is connected to a vertical local bus associated with the output cell; or (4) the control is connected to a horizontal local bus associated with the output cell. On power-up, the user I/Os are configured as inputs with pull-up resistors.

In addition to the functionality provided by the I/O logic, the entrance and exit cells provide the ability to register both inputs and outputs. Also, these perimeter cells (unlike interior cells) are connected directly to express buses: the edge-facing A and B outputs of the entrance cell are connected to express buses, as are the edge-facing A and B inputs of the exit cell. These buses are perpendicular to the edge, and provide a rapid means of bringing I/O signals to and from the array interior and the opposite edge of the chip.

Chip Configuration

The Integrated Development System generates the SRAM bit pattern required to configure a AT6000 Series device. A PC parallel port, microprocessor, EPROM or serial configuration memory can be used to download configuration patterns.

Users select from several configuration modes. Many factors, including board area, configuration speed and the number of designs implemented in parallel can influence the user's final choice.

Configuration is controlled by dedicated configuration pins and dual-function pins that double as I/O pins when the device is in operation. The number of dual-function pins required for each mode varies.

The devices can be partially reconfigured while in operation. Portions of the device not being modified remain operational during reconfiguration. Simultaneous configuration of more than one device is also possible. Full configuration takes as little as a millisecond, partial configuration is even faster.

Refer to the Pin Function Description section following for a brief summary of the pins used in configuration. For more information about configuration, refer to the AT6000 Series Configuration data sheet.

Pin Function Description

This section provides abbreviated descriptions of the various AT6000 Series pins. For more complete descriptions, refer to the AT6000 Series Configuration data sheet.

Pinout tables for the AT6000 series of devices follow.

Power Pins

V_{CC} , V_{DD} , GND, V_{SS}

 $\rm V_{CC}$ and GND are the I/O supply pins, $\rm V_{DD}$ and $\rm V_{SS}$ are the internal logic supply pins. $\rm V_{CC}$ and $\rm V_{DD}$ should be tied to the same trace on the printed circuit board. GND and $\rm V_{SS}$ should be tied to the same trace on the printed circuit board.

Input/Output Pins

All I/O pins can be used in the same way (refer to the I/O section of the architecture description). Some I/O pins are dual-function pins used during configuration of the array. When not being used for configuration, dual-function I/Os are fully functional as normal I/O pins. On initial power-up, all I/Os are configured as TTL inputs with a pull-up.

Dedicated Timing and Control Pins

CON

Configuration-in-process pin. After power-up, $\overline{\text{CON}}$ stay-sLow until power-up initialization is complete, at which time $\overline{\text{CON}}$ is then released. $\overline{\text{CON}}$ is an open collector signal. After power-up initialization, forcing $\overline{\text{CON}}$ low begins the configuration process.

CS

Configuration enable pin. All configuration pins are ignored if \overline{CS} is high. \overline{CS} must be held low throughout the configuration process. \overline{CS} is a TTL input pin.

MO, M1, M2

Configuration mode pins are used to determine the configuration mode. All three are TTL input pins.

CCLK

Configuration clock pin. CCLK is a TTL input or a CMOS output depending on the mode of operation. In modes 1, 2, 3, and 6 it is an input. In modes 4 and 5 it is an output with a typical frequency of 1 MHz. In all modes, the rising edge of the CCLK signal is used to sample inputs and change outputs.

CLOCK

External logic source used to drive the internal global clock line. Registers toggle on the rising edge of CLOCK. The CLOCK signal is neither used nor affected by the configuration modes. It is always a TTL input.

RESET

Array register asynchronous reset. RESET drives the internal global reset. The RESET signal is neither used nor affected by the configuration modes. It is always a TTL input.

Dual-function Pins

When $\overline{\text{CON}}$ is high, dual-function I/O pins act as device I/Os; when $\overline{\text{CON}}$ is low, dual-function pins are used as configuration control or data signals as determined by the configuration modes. Care must be taken when using these pins to ensure that configuration activity does not interfere with other circuitry connected to these pins in the application.

D0 or I/O

Serial configuration modes use D0 as the serial data input pin. Parallel configuration modes use D0 as the least-significant bit. Input data must meet setup and hold requirements with respect to the rising edge of CCLK. D0 is a TTL input during configuration.

D1 to D7 or I/O

Parallel configuration modes use these pins as inputs. Serial configuration modes do not use them. Data must meet setup and hold requirements with respect to the rising edge of CCLK. D1 - D7 are TTL inputs during configuration.

A0 to A16 or I/O

During configuration in modes 1, 2 and 5, these pins are CMOS outputs and act as the address pins for a parallel EPROM. A0 - A16 eliminates the need for an external address counter when using an external parallel nonvolatile





memory to configure the FPGA. Addresses change after the rising edge of the CCLK signal.

CSOUT or I/O

When cascading devices, $\overline{\text{CSOUT}}$ is an output used to enable other devices. $\overline{\text{CSOUT}}$ should be connected to the $\overline{\text{CS}}$ input of the downstream device. The $\overline{\text{CSOUT}}$ function is optional and can be disabled during initial programming when cascading is not used. When cascading devices, $\overline{\text{CSOUT}}$ should be dedicated to configuration and not used as a configurable I/O.

CHECK or I/O

During configuration, \overline{CHECK} is a TTL input that can be used to enable the data check function at the beginning of a configuration cycle. No data is written to the device while \overline{CHECK} is low. Instead, the configuration file being applied to D0 (or D0 - D7, in parallel mode) is compared with the

current contents of the internal configuration RAM. If a mismatch is detected between the data being loaded and the data already in the RAM, the $\overline{\text{ERR}}$ pin goes low. The $\overline{\text{CHECK}}$ function is optional and can be disabled during initial programming.

ERR or I/O

During configuration, \overline{ERR} is an output. When the \overline{CHECK} function is activated and a mismatch is detected between the current configuration data stream and the data already loaded in the configuration RAM, \overline{ERR} goes low. The \overline{ERR} ouput is a registered signal. Once a mismatch is found, the signal is set and is only reset after the configuration cycle is restarted. \overline{ERR} is also asserted for configuration file errors. The \overline{ERR} function is optional and can be disabled during initial programming.

Device Pinout Selection (Max. Number of User I/O)

| | AT6002 ⁽¹⁾ | AT6003 ⁽¹⁾ | AT6005 | AT6010 |
|-------------------------|-----------------------|-----------------------|---------|---------|
| 84 PLCC ⁽¹⁾ | 64 I/O | 64 I/O | 64 I/O | - |
| 100 VQFP | 80 I/O | 80 I/O | 80 I/O | - |
| 132 PQFP ⁽¹⁾ | 96 I/O | 108 I/O | - | - |
| 144 TQFP | 95 I/O | 120 I/O | 108 I/O | 120 I/O |
| 208 PQFP ⁽¹⁾ | - | - | - | - |
| 240 PQFP | - | - | - | 204 I/O |

Bit-stream Sizes

| Mode(s) | Туре | Beginning Sequence | AT6002 ⁽¹⁾ | AT6003 ⁽¹⁾ | AT6005 | AT6010 |
|---------|----------|--------------------|-----------------------|-----------------------|--------|--------|
| 1 | Parallel | Preamble | 2677 | 4153 | 8077 | 16393 |
| 2 | Parallel | Preamble | 2677 | 4153 | 8077 | 16393 |
| 3 | Serial | Null Byte/Preamble | 2678 | 4154 | 8078 | 16394 |
| 4 | Serial | Null Byte/Preamble | 2678 | 4154 | 8078 | 16394 |
| 5 | Parallel | Preamble | 2677 | 4153 | 8077 | 16393 |
| 6 | Parallel | Preamble/Preamble | 2678 | 4154 | 8078 | 16394 |

| Note: | 1. | | Obsolete. Not recommended for new design |
|-------|----|--|--|
|-------|----|--|--|

| | | | Left Side | (Top to Bo | ttom) | | | | | |
|-----------------------|-----------------------|----------------|----------------|---------------------------|-------------|----------------------------|-------------|----------------------------|----------------------------|----------------------------|
| AT6002 ⁽³⁾ | AT6003 ⁽³⁾ | AT6005 | AT6010 | 84 ⁽³⁾ PLCC | 100 VQFP | 132 ⁽³⁾ PQFP | 144 TQFP | 180 ⁽³⁾ CPGA | 208 ⁽³⁾ PQFP | 240 ⁽³⁾ PQFP |
| - | - | - | I/O51(A) | - | - | - | - | B1 | 1 | 1 |
| I/O24(A) or A7 | I/O30(A) or A7 | I/O27(A) or A7 | I/O50(A) or A7 | 12 | 1 | 18 | 1 | C1 | 2 | 2 |
| - | I/O29(B) | - | I/O49(A) | - | - | - | 2 | D1 | 3 | 3 |
| - | - | - | I/O48(B) | - | - | - | - | - | - | 4 |
| - | - | - | vcc | - | - | - | - | PWR ⁽¹ | 4 | 5 |
| - | - | - | I/O47(A) | - | - | - | - | E1 | 5 | 6 |
| - | - | = | GND | - | - | - | - | GND ⁽²⁾ | 6 | 7 |
| - | I/O28(A) | I/O26(A) | I/O46(A) | - | - | 19 | 3 | G1 | 7 | 8 |
| I/O23(A) or A6 | I/O27(A) or A6 | I/O25(A) or A6 | I/O45(A) or A6 | 13 | 2 | 20 | 4 | H1 | 8 | 9 |
| - | - | = | I/O44(B) | - | - | - | - | - | - | 10 |
| - | - | - | I/O43(A) | - | - | - | - | C2 | 9 | 11 |
| I/O22(B) | I/O26(A) | I/O24(A) | I/O42(A) | - | - | 21 | 5 | D2 | 10 | 12 |
| I/O21(A) or A5 | I/O25(A) or A5 | I/O23(A) or A5 | I/O41(A) or A5 | 14 | 3 | 22 | 6 | E2 | 11 | 13 |
| - | - | - | I/O40(B) | - | - | - | - | - | - | 14 |
| - | - | - | I/O39(A) | - | - | - | - | F2 | 12 | 15 |
| I/O20(B) | I/O24(B) | I/O22(A) | I/O38(A) | - | 4 | 23 | 7 | G2 | 13 | 16 |
| I/O19(A) or A4 | I/O23(A) or A4 | I/O21(A) or A4 | I/O37(A) or A4 | 15 | 5 | 24 | 8 | H2 | 14 | 17 |
| - | - | - | I/O36(B) | - | - | - | - | - | - | 18 |
| I/O18(B) | I/O22(B) | I/O20(A) | I/O35(A) | - | - | 25 | 9 | D3 | 15 | 19 |
| I/O17(A) or A3 | I/O21(A) or A3 | I/O19(A) or A3 | I/O34(A) or A3 | 16 | 6 | 26 | 10 | E3 | 16 | 20 |
| I/O16(B) | I/O20(B) | I/O18(A) | I/O33(A) | - | 7 | 27 | 11 | F3 | 17 | 21 |
| - | - | - | I/O32(B) | - | - | - | - | - | 18 | 22 |
| I/O15(A) or A2 | I/O19(A) or A2 | I/O17(A) or A2 | I/O31(A) or A2 | 17 | 8 | 28 | 12 | G3 | 19 | 23 |
| - | I/O18(B) | I/O16(A) | I/O30(A) | - | - | 29 | 13 | НЗ | 20 | 24 |
| GND | GND | GND | GND | 18 | 9 | 30 | 14 | GND ⁽²⁾ | 21 | 25 |
| VSS | VSS | VSS | VSS | 19 | 10 | 31 | 15 | GND ⁽²⁾ | 22 | 26 |
| I/O14(A) or A1 | I/O17(A) or A1 | I/O15(A) or A1 | I/O29(A) or A1 | 20 | 11 | 32 | 16 | F4 | 23 | 27 |
| - | - | - | I/O28(B) | - | - | - | - | - | 24 | 28 |
| - | I/O16(B) | - | I/O27(A) | - | - | - | 17 | G4 | 25 | 29 |
| I/O13(A) or A0 | I/O15(A) or A0 | I/O14(A) or A0 | I/O26(A) or A0 | 21 | 12 | 33 | 18 | H4 | 26 | 30 |
| I/O12(B) or D7 | I/O14(A) or D7 | I/O13(A) or D7 | I/O25(B) or D7 | 22 | 13 | 34 | 19 | H5 | 27 | 31 |
| - | - | - | I/O24(B) | - | - | - | - | - | 28 | 32 |
| I/O11(A) or D6 | I/O13(A) or D6 | I/O12(A) or D6 | I/O23(A) or D6 | 23 | 14 | 35 | 20 | J4 | 29 | 33 |

Notes: 1. PWR = Pins connected to power plane = F1, E4/E5, L2, R4, K15, L12, E14, A12.



^{2.} GND = Pins connected to ground plane = L4, M4, N9, N10, E12, D12, C7, C6.



Pinout Assignment (Continued)

| | | | Left Side | (Top to Bo | ttom) | | | | | |
|-----------------------|-----------------------|----------------|----------------|---------------------------|-------------|----------------------------|-------------|----------------------------|----------------------------|----------------------------|
| AT6002 ⁽³⁾ | AT6003 ⁽³⁾ | AT6005 | AT6010 | 84 ⁽³⁾ PLCC | 100 VQFP | 132 ⁽³⁾ PQFP | 144 TQFP | 180 ⁽³⁾ CPGA | 208 ⁽³⁾ PQFP | 240 ⁽³⁾ PQFP |
| I/O10(A) or D5 | I/O12(A) or D5 | I/O11(A) or D5 | I/O22(A) or D5 | 24 | 15 | 36 | 21 | K4 | 30 | 34 |
| VDD | VDD | VDD | VDD | 25 | 16 | 37 | 22 | PWR ⁽¹ | 31 | 35 |
| vcc | vcc | vcc | vcc | 26 | 17 | 38 | 23 | PWR ⁽¹ | 32 | 36 |
| I/O9(B) | I/O11(B) | I/O10(A) | I/O21(A) | - | - | 39 | 24 | J3 | 33 | 37 |
| - | - | - | I/O20(B) | - | - | - | - | - | 34 | 38 |
| I/O8(A) or D4 | I/O10(A) or D4 | I/O9(A) or D4 | I/O19(A) or D4 | 27 | 18 | 40 | 25 | K3 | 35 | 39 |
| I/O7(B) | I/O9(B) | I/O8(A) | I/O18(A) | - | 19 | 41 | 26 | L3 | 36 | 40 |
| - | - | - | I/O17(A) | - | - | - | - | МЗ | 37 | 41 |
| - | - | - | I/O16(B) | - | - | - | - | - | - | 42 |
| I/O6(A) or D3 | I/O8(A) or D3 | I/O7(A) or D3 | I/O15(A) or D3 | 28 | 20 | 42 | 27 | N3 | 38 | 43 |
| - | I/O7(B) | I/O6(A) | I/O14(A) | - | - | 43 | 28 | J2 | 39 | 44 |
| - | - | - | I/O13(A) | - | - | - | - | K2 | 40 | 45 |
| GND | GND | GND | GND | - | - | 44 | 29 | GND ⁽²⁾ | 41 | 46 |
| - | - | - | vss | - | - | - | - | GND ⁽²⁾ | 42 | 47 |
| - | - | - | I/O12(B) | - | - | - | - | - | - | 48 |
| I/O5(A) or D2 | I/O6(A) or D2 | I/O5(A) or D2 | I/O11(A) or D2 | 29 | 21 | 45 | 30 | M2 | 43 | 49 |
| I/O4(B) | I/O5(B) | I/O4(A) | I/O10(A) | - | 22 | 46 | 31 | N2 | 44 | 50 |
| - | - | - | I/O9(A) | - | - | - | - | P2 | 45 | 51 |
| - | - | - | I/O8(B) | - | - | - | - | - | - | 52 |
| I/O3(A) or D1 | I/O4(A) or D1 | I/O3(A) or D1 | I/O7(A) or D1 | 30 | 23 | 47 | 32 | J1 | 46 | 53 |
| I/O2(B) | I/O3(A) | I/O2(A) | I/O6(A) | - | - | 48 | 33 | K1 | 47 | 54 |
| - | - | - | I/O5(A) | - | - | - | - | L1 | 48 | 55 |
| - | - | - | I/O4(B) | - | - | - | - | - | - | 56 |
| - | I/O2(B) | - | I/O3(A) | - | - | - | 34 | M1 | 49 | 57 |
| I/O1(A) or D0 | I/O1(A) or D0 | I/O1(A) or D0 | I/O2(A) or D0 | 31 | 24 | 49 | 35 | N1 | 50 | 58 |
| - | - | - | I/O1(A) | - | - | - | - | P1 | 51 | 59 |
| CCLK | CCLK | CCLK | CCLK | 32 | 25 | 50 | 36 | R1 | 52 | 60 |

Notes: 1. PWR = Pins connected to power plane = F1, E4/E5, L2, R4, K15, L12, E14, A12.

^{2.} GND = Pins connected to ground plane = L4, M4, N9, N10, E12, D12, C7, C6.

| | | | Bottom S | ide (Left to | Right) | | | | | |
|-----------------------|-----------------------|-----------------------|-----------------------|---------------------------|-------------|----------------------------|-------------|----------------------------|----------------------------|----------------------------|
| AT6002 ⁽³⁾ | AT6003 ⁽³⁾ | AT6005 | AT6010 | 84 ⁽³⁾ PLCC | 100 VQFP | 132 ⁽³⁾ PQFP | 144 TQFP | 180 ⁽³⁾ CPGA | 208 ⁽³⁾ PQFP | 240 ⁽³⁾ PQFP |
| CON | CON | CON | CON | 33 | 26 | 51 | 37 | M5 | 53 | 61 |
| - | - | - | I/O204(A) | - | - | - | - | M6 | 54 | 62 |
| I/O96(A) | I/O120(A) | I/O108(A) | I/O203(A) | 34 | 27 | 52 | 38 | M7 | 55 | 63 |
| - | I/O119(B) | - | I/O202(A) | - | - | - | 39 | R2 | 56 | 64 |
| - | - | - | I/O201(B) | - | - | - | - | - | - | 65 |
| - | - | - | VCC | - | - | - | - | PWR ⁽¹⁾ | 57 | 66 |
| - | - | - | I/O200(A) | - | - | - | - | R3 | 58 | 67 |
| - | - | - | GND | - | - | - | - | GND ⁽²⁾ | 59 | 68 |
| - | I/O118(A) | I/O107(A) | I/O199(A) | - | - | 53 | 40 | R5 | 60 | 69 |
| I/O95(A) or CSOUT | I/O117(A) or CSOUT | I/O106(A) or CSOUT | I/O198(A) or CSOUT | 35 | 28 | 54 | 41 | R6 | 61 | 70 |
| - | - | - | I/O197(B) | - | - | - | - | - | - | 71 |
| - | - | - | I/O196(A) | - | - | - | - | R7 | 62 | 72 |
| I/O94(B) | I/O116(A) | I/O105(A) | I/O195(A) | - | - | 55 | 42 | P3 | 63 | 73 |
| I/O93(A) | I/O115(A) | I/O104(A) | I/O194(A) | 36 | 29 | 56 | 43 | P4 | 64 | 74 |
| - | - | - | I/O193(B) | - | - | - | - | - | - | 75 |
| - | - | - | I/O192(A) | - | - | - | - | P5 | 65 | 76 |
| I/O92(B) | I/O114(B) | I/O103(A) | I/O191(A) | - | 30 | 57 | 44 | P6 | 66 | 77 |
| I/O91(A) or CHECK | I/O113(A) or CHECK | I/O102(A) or CHECK | I/O190(A) or CHECK | 37 | 31 | 58 | 45 | P7 | 67 | 78 |
| - | - | - | I/O189(B) | - | - | - | - | - | - | 79 |
| I/O90(B) | I/O112(B) | I/O101(A) | I/O188(A) | - | - | 59 | 46 | N4 | 68 | 80 |
| I/O89(A) or ERR | I/O111(A) or ERR | I/O100(A) or ERR | I/O187(A) or ERR | 38 | 32 | 60 | 47 | N5 | 69 | 81 |
| I/O88(B) | I/O110(B) | I/O99(A) | I/O186(A) | - | 33 | 61 | 48 | N6 | 70 | 82 |
| - | - | - | I/O185(B) | - | - | - | - | - | 71 | 83 |
| I/O87(A) | I/O109(A) | I/O98(A) | I/O184(A) | 39 | 34 | 62 | 49 | N7 | 72 | 84 |
| - | I/O108(B) | I/O97(A) | I/O183(A) | - | - | 63 | 50 | M8 | 73 | 85 |
| GND | GND | GND | GND | 40 | 35 | 64 | 51 | GND ⁽²⁾ | 74 | 86 |
| I/O86(A) | I/O107(A) | I/O96(A) | I/O182(A) | 41 | 36 | 65 | 52 | M9 | 75 | 87 |
| - | - | - | I/O181(B) | - | - | - | - | - | 76 | 88 |
| - | I/O106(B) | - | I/O180(A) | - | - | - | 53 | M10 | 77 | 89 |
| I/O85(A) | I/O105(A) | I/O95(A) | I/O179(A) | 42 | 37 | 66 | 54 | M11 | 78 | 90 |
| CS | CS | CS | CS | 43 | 38 | 67 | 55 | L8 | 79 | 91 |
| I/O84(B) | I/O104(A) | I/O94(A) | I/O178(A) | 44 | 39 | 68 | 56 | M12 | 80 | 92 |

Notes: 1. PWR = Pins connected to power plane = F1, E4/E5, L2, R4, K15, L12, E14, A12.

^{3.} Obsolete. Not recommended for new design.



^{2.} GND = Pins connected to ground plane = L4, M4, N9, N10, E12, D12, C7, C6.

| | | | Right Sic | de (Bottom t | о Тор) | | | | | |
|-----------------------|-----------------------|----------|-----------|---------------------------|-------------|----------------------------|-------------|----------------------------|----------------------------|----------------------------|
| AT6002 ⁽⁵⁾ | AT6003 ⁽⁵⁾ | AT6005 | AT6010 | 84 ⁽⁵⁾ PLCC | 100 VQFP | 132 ⁽⁵⁾ PQFP | 144 TQFP | 180 ⁽⁵⁾ CPGA | 208 ⁽⁵⁾ PQFP | 240 ⁽⁵⁾ PQFP |
| - | - | - | I/O153(A) | - | - | - | - | P15 | 105 | 121 |
| I/O72(A) | I/O90(A) | I/O81(A) | I/O152(A) | 54 | 51 | 84 | 73 | N15 | 106 | 122 |
| - | I/O89(B) | I/O80(A) | I/O151(A) | - | - | 85 ⁽³⁾ | 74 | M15 | 107 | 123 |
| - | - | - | I/O150(B) | - | - | - | - | - | - | 124 |
| - | - | - | vcc | - | - | - | - | PWR ⁽¹ | 108 | 125 |
| - | - | - | I/O149(A) | - | - | - | - | L15 | 109 | 126 |
| - | - | - | GND | - | - | - | - | GND ⁽²⁾ | 110 | 127 |
| - | I/O88(A) | - | I/O148(A) | - | - | 85 ⁽⁴⁾ | 75 | J15 | 111 | 128 |
| I/O71(A) | I/O87(A) | I/O79(A) | I/O147(A) | 55 | 52 | 86 | 76 | H15 | 112 | 129 |
| - | - | - | I/O146(B) | - | - | - | - | - | - | 130 |
| - | - | - | I/O145(A) | - | - | - | - | N14 | 113 | 131 |
| I/O70(B) | I/O86(A) | I/O78(A) | I/O144(A) | - | - | 87 | 77 | M14 | 114 | 132 |
| I/O69(A) | I/O85(A) | I/O77(A) | I/O143(A) | 56 | 53 | 88 | 78 | L14 | 115 | 133 |
| - | - | - | I/O142(B) | - | - | - | - | - | - | 134 |
| - | - | - | I/O141(A) | - | - | - | - | K14 | 116 | 135 |
| I/O68(B) | I/O84(B) | I/O76(A) | I/O140(A) | - | 54 | 89 | 79 | J14 | 117 | 136 |
| I/O67(A) | I/O83(A) | I/O75(A) | I/O139(A) | 57 | 55 | 90 | 80 | H14 | 118 | 137 |
| - | - | - | I/O138B | - | - | - | - | - | - | 138 |
| I/O66(B) | I/O82(B) | I/O74(A) | I/O137(A) | - | - | 91 | 81 | M13 | 119 | 139 |
| I/O65(A) | I/O81(A) | I/O73(A) | I/O136(A) | 58 | 56 | 92 | 82 | L13 | 120 | 140 |
| I/O64(B) | I/O80(B) | I/O72(A) | I/O135(A) | - | 57 | 93 | 83 | K13 | 121 | 141 |
| - | - | - | I/O134(B) | - | - | - | - | - | 122 | 142 |
| I/O63(A) | I/O79(A) | I/O71(A | I/O133(A) | 59 | 58 | 94 | 84 | J13 | 123 | 143 |
| - | I/O78(B) | I/O70(A) | I/O132(A) | - | - | 95 | 85 | H13 | 124 | 144 |
| GND | GND | GND | GND | 60 | 59 | 96 | 86 | GND ⁽²⁾ | 125 | 145 |
| VSS | VSS | VSS | VSS | 61 | 60 | 97 | 87 | GND ⁽²⁾ | 126 | 146 |
| I/O62(A) | I/O77(A) | I/O69(A) | I/O131(A) | 62 | 61 | 98 | 88 | K12 | 127 | 147 |
| - | - | - | I/O130(B) | - | - | - | - | - | 128 | 148 |
| - | I/O76(B) | - | I/O129(A) | - | - | - | 89 | J12 | 129 | 149 |
| I/O61(A) | I/O75(A) | I/O68(A) | I/O128(A) | 63 | 62 | 99 | 90 | H12 | 130 | 150 |
| I/O60(B) | I/O74(A) | I/O67(A) | I/O127(A) | 64 | 63 | 100 | 91 | H11 | 131 | 151 |
| - | - | - | I/O126(B) | - | - | - | - | - | 132 | 152 |

Notes: 1. PWR = Pins connected to power plane = F1, E4/E5, L2, R4, K15, L12, E14, A12.



^{2.} GND = Pins connected to ground plane = L4, M4, N9, N10, E12, D12, C7, C6.

^{3. 85 =} Pin 85 on AT6005.

^{4. 85 =} Pin 85 on AT6003 and AT6010.



Pinout Assignment (Continued)

| | | | Right Side | (Bottom to | о Тор) | | | | | |
|-----------------------|-----------------------|----------|------------|---------------------------|-------------|----------------------------|-------------|----------------------------|----------------------------|----------------------------|
| AT6002 ⁽⁵⁾ | AT6003 ⁽⁵⁾ | AT6005 | AT6010 | 84 ⁽⁵⁾ PLCC | 100 VQFP | 132 ⁽⁵⁾ PQFP | 144 TQFP | 180 ⁽⁵⁾ CPGA | 208 ⁽⁵⁾ PQFP | 240 ⁽⁵⁾ PQFP |
| I/O59(A) | I/O73(A) | I/O66(A) | I/O125(A) | 65 | 64 | 101 | 92 | G12 | 133 | 153 |
| I/O58(A) | I/O72(A) | I/O65(A) | I/O124(A) | 66 | 65 | 102 | 93 | F12 | 134 | 154 |
| VDD | VDD | VDD | VDD | 67 | 66 | 103 | 94 | PWR ⁽¹ | 135 | 155 |
| vcc | vcc | vcc | vcc | 68 | 67 | 104 | 95 | PWR ⁽¹ | 136 | 156 |
| I/O57(B) | I/O71(B) | I/O64(A) | I/O123(A) | - | - | 105 | 96 | G13 | 137 | 157 |
| - | - | - | I/O122(B) | - | - | - | - | - | 138 | 158 |
| I/O56(A) | I/O70(A) | I/O63(A) | I/O121(A) | 69 | 68 | 106 | 97 | F13 | 139 | 159 |
| I/O55(B) | I/O69(B) | I/O62(A) | I/O120(A) | - | 69 | 107 | 98 | E13 | 140 | 160 |
| - | - | - | I/O119(A) | - | - | - | - | D13 | 141 | 161 |
| - | - | - | I/O118(B) | - | - | - | - | - | - | 162 |
| I/O54(A) | I/O68(A) | I/O61(A) | I/O117(A) | 70 | 70 | 108 | 99 | C13 | 142 | 163 |
| - | I/O67(B) | I/O60(A) | I/O116(A) | - | - | 109 | 100 | G14 | 143 | 164 |
| - | - | - | I/O115(A) | - | - | - | - | F14 | 144 | 165 |
| GND | GND | GND | GND | - | - | 110 | 101 | GND ⁽²⁾ | 145 | 166 |
| - | - | - | VSS | - | - | - | - | GND ⁽²⁾ | 146 | 167 |
| - | - | - | I/O114(B) | - | - | - | - | - | - | 168 |
| I/O53(A) | I/O66(A) | I/O59(A) | I/O113(A) | 71 | 71 | 111 | 102 | D14 | 147 | 169 |
| I/O52(B) | I/O65(B) | I/O58(A) | I/O112(A) | - | 72 | 112 | 103 | C14 | 148 | 170 |
| - | - | - | I/O111(A) | - | - | - | - | B14 | 149 | 171 |
| - | - | - | I/O110(B) | - | - | - | - | - | - | 172 |
| I/O51(A) | I/O64(A) | I/O57(A) | I/O109(A) | 72 | 73 | 113 | 104 | G15 | 150 | 173 |
| I/O50(B) | I/O63(A) | I/O56(A) | I/O108(A) | - | - | 114 | 105 | F15 | 151 | 174 |
| - | - | - | I/O107(A) | - | - | - | - | E15 | 152 | 175 |
| - | - | - | I/O106(B) | - | - | - | - | - | - | 176 |
| - | I/O62(B) | - | I/O105(A) | - | - | - | 106 | D15 | 153 | 177 |
| I/O49(A) | I/O61(A) | I/O55(A) | I/O104(A) | 73 | 74 | 115 | 107 | C15 | 154 | 178' |
| - | - | - | I/O103(A) | - | - | - | - | B15 | 155 | 179 |
| M2 | M2 | M2 | M2 | 74 | 75 | 116 | 108 | A15 | 156 | 180 |

Notes: 1. PWR = Pins connected to power plane = F1, E4/E5, L2, R4, K15, L12, E14, A12.

^{2.} GND = Pins connected to ground plane = L4, M4, N9, N10, E12, D12, C7, C6.

^{3.} 85 = Pin 85 on AT6005.

^{4. 85 =} Pin 85 on AT6003 and AT6010.

| | | | Top Sid | e (Right to | Left) | | | | | |
|-----------------------|-----------------------|--------------------|--------------------|---------------------------|-------------|----------------------------|-------------|----------------------------|----------------------------|----------------------------|
| AT6002 ⁽³⁾ | AT6003 ⁽³⁾ | AT6005 | AT6010 | 84 ⁽³⁾ PLCC | 100 VQFP | 132 ⁽³⁾ PQFP | 144 TQFP | 180 ⁽³⁾ CPGA | 208 ⁽³⁾ PQFP | 240 ⁽³⁾ PQFP |
| M1 | M1 | M1 | M1 | 75 | 76 | 117 | 109 | D11 | 157 | 181 |
| - | - | - | I/O102(A) | - | - | - | - | D10 | 158 | 182 |
| I/O48(A) | I/O60(A) | I/O54(A) | I/O101(A) | 76 | 77 | 118 | 110 | D9 | 159 | 183 |
| - | I/O59(B) | - | I/O100(A) | - | - | - | 111 | A14 | 160 | 184 |
| - | - | - | I/O99(B) | - | - | - | - | - | • | 185 |
| - | - | - | VCC | - | - | - | - | PWR ⁽¹ | 161 | 186 |
| - | - | - | I/O98(A) | - | - | - | - | A13 | 162 | 187 |
| - | - | - | GND | - | - | - | - | GND ⁽²⁾ | 163 | 188 |
| - | I/O58(A) | I/O53(A) | I/O97(A) | - | - | 119 | 112 | A11 | 164 | 189 |
| I/O47(A) | I/O57(A) | I/O52(A) | I/O96(A) | 77 | 78 | 120 | 113 | A10 | 165 | 190 |
| - | - | - | I/O95(B) | - | - | - | - | - | - | 191 |
| - | - | - | I/O94(A) | - | - | - | - | A9 | 166 | 192 |
| I/O46(B) | I/O56(A) | I/O51(A) | I/O93(A) | - | - | 121 | 114 | B13 | 167 | 193 |
| I/O45(A) | I/O55(A) | I/O50(A) | I/O92(A) | 78 | 79 | 122 | 115 | B12 | 168 | 194 |
| - | - | - | I/O91(B) | - | - | - | - | - | - | 195 |
| - | - | - | I/O90(A) | - | - | - | - | B11 | 169 | 196 |
| I/O44(B) | I/O54(B) | I/O49(A) | I/O89(A) | - | 80 | 123 | 116 | B10 | 170 | 197 |
| I/O43(A) | I/O53(A) | I/O48(A) | I/O88(A) | 79 | 81 | 124 | 117 | B9 | 171 | 198 |
| - | - | - | I/O87(B) | - | - | - | - | - | - | 199 |
| I/O42(B) | I/O52(B) | I/O47(A) | I/O86(A) | - | - | 125 | 118 | C12 | 172 | 200 |
| I/O41(A) | I/O51(A) | I/O46(A) | I/O85(A) | 80 | 82 | 126 | 119 | C11 | 173 | 201 |
| I/O40(B) | I/O50(B) | I/O45(A) | I/O84(A) | - | 83 | 127 | 120 | C10 | 174 | 202 |
| - | - | - | I/O83(B) | - | - | - | - | - | 175 | 203 |
| I/O39(A) | I/O49(A) | I/O44(A) | I/O82(A) | 81 | 84 | 128 | 121 | C9 | 176 | 204 |
| - | I/O48(B) | I/O43(A) | I/O81(A) | - | - | 129 | 122 | D8 | 177 | 205 |
| GND | GND | GND | GND | 82 | 85 | 130 | 123 | GND ⁽²⁾ | 178 | 206 |
| I/O38(A) | I/O47(A) | I/O42(A) | I/O80(A) | 83 | 86 | 131 | 124 | D7 | 179 | 207 |
| - | - | - | I/O79(B) | - | - | - | - | - | 180 | 208 |
| - | I/O46(B) | - | I/O78(A) | - | - | - | 125 | D6 | 181 | 209 |
| I/O37(A) or A16 | I/O45(A) or A16 | I/O41(A) or A16 | I/O77(A) or A16 | 84 | 87 | 132 | 126 | D5 | 182 | 210 |
| CLOCK | CLOCK | CLOCK | CLOCK | 1 | 88 | 1 | 127 | E8 | 183 | 211 |
| I/O36(B) or A15 | I/O44(B) or A15 | I/O40(A) or A15 | I/O76(A) or A15 | 2 | 89 | 2 | 128 | D4 | 184 | 212 |

Notes: 1. PWR = Pins connected to power plane = F1, E4/E5, L2, R4, K15, L12, E14, A12.

^{3.} Obsolete. Not recommended for new design.



^{2.} GND = Pins connected to ground plane = L4, M4, N9, N10, E12, D12, C7, C6.

AC Timing Characteristics – 5V Operation

Delays are based on fixed load. Loads for each type of device are described in the notes. Delays are in nanoseconds. Worst case: $V_{CC} = 4.75V$ to 5.25V. Temperature = 0°C to 70°C.

| Cell Function | Parameter | From | То | Load Definition ⁽⁷⁾ | -1 | -2 | -4 | Units |
|-------------------------------|--------------------------------------|-------------|---------|-----------------------------------|-----|-----|------|-------|
| Wire ⁽⁴⁾ | t _{PD} (max) ⁽⁴⁾ | A, B, L | A, B | 1 | 0.8 | 1.2 | 1.8 | ns |
| NAND | t _{PD} (max) | A, B, L | В | 1 | 1.6 | 2.2 | 3.2 | ns |
| XOR | t _{PD} (max) | A, B, L | Α | 1 | 1.8 | 2.4 | 4.0 | ns |
| AND | t _{PD} (max) | A, B, L | В | 1 | 1.7 | 2.2 | 3.2 | ns |
| MILIV | h (mm) | A, B | Α | 1 | 1.7 | 2.3 | 4.0 | ns |
| MUX | t _{PD} (max) | L | Α | 1 | 2.1 | 3.0 | 4.9 | ns |
| D-Flip-flop ⁽⁵⁾ | t _{setup} (min) | A, B, L | CLK | - | 1.5 | 2.0 | 3.0 | ns |
| D-Flip-flop ⁽⁵⁾ | t _{hold} (min) | CLK | A, B, L | - | 0 | 0 | 0 | ns |
| D-Flip-flop | t _{PD} (max) | CLK | Α | 1 | 1.5 | 2.0 | 3.0 | ns |
| Bus Driver | t _{PD} (max) | А | L | 2 | 2.0 | 2.6 | 4.0 | ns |
| Damastar | h (m.n.) | L, E | E | 3 | 1.3 | 1.6 | 2.3 | ns |
| Repeater | t _{PD} (max) | L, E | L | 2 | 1.7 | 2.1 | 3.0 | ns |
| Column Clock | t _{PD} (max) | GCLK, A, ES | CLK | 3 | 1.8 | 2.4 | 3.0 | ns |
| Column Reset | t _{PD} (max) | GRES, A, EN | RES | 3 | 1.8 | 2.4 | 3.0 | ns |
| Clock Buffer ⁽⁵⁾ | t _{PD} (max) | CLOCK PIN | GCLK | - | 1.6 | 2.0 | 2.9 | ns |
| Reset Buffer ⁽⁵⁾ | t _{PD} (max) | RESET PIN | GRES | - | 1.5 | 1.9 | 2.8 | ns |
| TTL Input ⁽¹⁾ | t _{PD} (max) | I/O | Α | 3 | 1.0 | 1.2 | 1.5 | ns |
| CMOS Input ⁽²⁾ | t _{PD} (max) | I/O | Α | 3 | 1.3 | 1.4 | 2.3 | ns |
| Fast Output ⁽³⁾ | t _{PD} (max) | А | I/O PIN | 4 | 3.3 | 3.5 | 6.0 | ns |
| Slow Output ⁽³⁾ | t _{PD} (max) | А | I/O PIN | 4 | 7.5 | 8.0 | 12.0 | ns |
| Output Disable ⁽⁵⁾ | t _{PXZ} (max) | L | I/O PIN | 4 | 3.1 | 3.3 | 5.5 | ns |
| Fast Enable ⁽³⁾⁽⁵⁾ | t _{PXZ} (max) | L | I/O PIN | 4 | 3.8 | 4.0 | 6.5 | ns |
| Slow Enable ⁽³⁾⁽⁵⁾ | t _{PXZ} (max) | L | I/O PIN | 4 | 8.2 | 8.5 | 12.5 | ns |

| Device | Cell Types | Outputs | I _{CC} (max) |
|-----------------------------|--|---------|-----------------------|
| Cell ⁽⁶⁾ | Wire, XWire, Half-adder, Flip-flop | A, B | 4.5 μA/MHz |
| Bus ⁽⁶⁾ | Wire, XWire, Half-adder, Flip-flop, Repeater | L | 2.5 μA/MHz |
| Column Clock ⁽⁶⁾ | Column Clock Driver | CLK | 40 μA/MHz |

Notes:

- 1. TTL buffer delays are measured from a V_{IH} of 1.5V at the pad to the internal V_{IH} at A. The input buffer load is constant.
- 2. CMOS buffer delays are measured from a V_{IH} of 1/2 V_{CC} at the apd to the internal V_{IH} at A. The input buffer load is constant.
- 3. Buffer delay is to a pad voltage of 1.5V with one output switching.
- 4. Max specifications are the average of mas t_{PDLH} and t_{PDHL} .
- 5. Parameter based on characterization and simulation; not tested in production
- 6. Exact power calculation is available in an Atmel application note.
- 7. Load Definition: 1 = Load of one A or B input; 2 = Load of one L input; 3 = Constant Load; 4 = Tester Load of 50 pF.





AC Timing Characteristics – 3.3V Operation (8)

Delays are based on fixed load. Loads for each type of device are described in the notes. Delays are in nanoseconds. Worst case: $V_{CC} = 3.0V$ to 3.6V. Temperature = 0°C to 70°C.

| Cell Function | Parameter | From | То | Load Definition ⁽⁷⁾ | -4 | Units |
|-------------------------------|--------------------------------------|-------------|---------|-----------------------------------|------|-------|
| Wire ⁽⁴⁾ | t _{PD} (max) ⁽⁴⁾ | A, B, L | A, B | 1 | 1.8 | ns |
| NAND | t _{PD} (max) | A, B, L | В | 1 | 3.2 | ns |
| XOR | t _{PD} (max) | A, B, L | Α | 1 | 4.0 | ns |
| AND | t _{PD} (max) | A, B, L | В | 1 | 3.2 | ns |
| MUX | t (may) | A, B | Α | 1 | 4.0 | ns |
| WOX | t _{PD} (max) | L | Α | 1 | 4.9 | ns |
| D-Flip-flop ⁽⁵⁾ | t _{setup} (min) | A, B, L | CLK | - | 3.0 | ns |
| D-Flip-flop ⁽⁵⁾ | t _{hold} (min) | CLK | A, B, L | - | 0 | ns |
| D-Flip-flop | t _{PD} (max) | CLK | Α | 1 | 3.0 | ns |
| Bus Driver | t _{PD} (max) | A | L | 2 | 4.0 | ns |
| Г. | t _{PD} (max) | L, E | E | 3 | 2.3 | ns |
| Repeater | | L, E | L | 2 | 3.0 | ns |
| Column Clock | t _{PD} (max) | GCLK, A, ES | CLK | 3 | 3.0 | ns |
| Column Reset | t _{PD} (max) | GRES, A, EN | RES | 3 | 3.0 | ns |
| Clock Buffer ⁽⁵⁾ | t _{PD} (max) | CLOCK PIN | GCLK | 4 | 2.9 | ns |
| Reset Buffer ⁽⁵⁾ | t _{PD} (max) | RESET PIN | GRES | 5 | 2.8 | ns |
| TTL Input ⁽¹⁾ | t _{PD} (max) | I/O | А | 3 | 1.5 | ns |
| CMOS Input ⁽²⁾ | t _{PD} (max) | I/O | А | 3 | 2.3 | ns |
| Fast Output ⁽³⁾ | t _{PD} (max) | A | I/O PIN | 6 | 6.0 | ns |
| Slow Output ⁽³⁾ | t _{PD} (max) | A | I/O PIN | 6 | 12.0 | ns |
| Output Disable ⁽⁵⁾ | t _{PXZ} (max) | L | I/O PIN | 6 | 5.5 | ns |
| Fast Enable ⁽³⁾⁽⁵⁾ | t _{PXZ} (max) | L | I/O PIN | 6 | 6.5 | ns |
| Slow Enable ⁽³⁾⁽⁵⁾ | t _{PXZ} (max) | L | I/O PIN | 6 | 12.5 | ns |

| Device | Cell Types | Outputs | I _{CC} (max) |
|-----------------------------|--|---------|-----------------------|
| Cell ⁽⁶⁾ | Wire, XWire, Half-adder, Flip-flop | A, B | 2.3 μA/MHz |
| Bus ⁽⁶⁾ | Wire, XWire, Half-adder, Flip-flop, Repeater | L | 1.3 μA/MHz |
| Column Clock ⁽⁶⁾ | Column Clock Driver | CLK | 20 μA/MHz |

Notes

- 1. TTL buffer delays are measured from a V_{IH} of 1.5V at the pad to the internal V_{IH} at A. The input buffer load is constant.
- 2. CMOS buffer delays are measured from a V_{IH} of 1/2 V_{CC} at the apd to the internal V_{IH} at A. The input buffer load is constant.
- 3. Buffer delay is to a pad voltage of 1.5V with one output switching.
- 4. Max specifications are the average of mas t_{PDLH} and t_{PDHL} .
- 5. Parameter based on characterization and simulation; not tested in production
- 6. Exact power calculation is available in an Atmel application note.
- 7. Load Definition: 1 = Load of one A or B input; 2 = Load of one L input; 3 = Constant Load; 4 = Load of 28 Clock Columns; 5 = Load of 28 Reset Columns; 6 = Tester Load of 50 pF.
- 8. Obsolete. Not recommended for new design.

Absolute Maximum Ratings*

| Supply Voltage (V _{CC})0.5V to + 7.0V |
|--|
| DC Input Voltage (V _{IN})0.5V to V _{CC} + 0.5V |
| DC Output Voltage (V _{ON})0.5V to V _{CC} + 0.5V |
| Storage Temperature Range (TSTG)65 °C to +150 °C |
| Power Dissipation (PD)1500 mW |
| Lead Temperature (T _L) (Soldering, 10 sec.)260°C |
| ESD (R _{ZAP} = 1.5K, C _{ZAP} = 100 pF)2000V |

*NOTICE:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress rating only and functional operation of the device at these or any other conditions beyond those listed under operating conditions is not implied. Exposure to Absolute Maximum Rating conditions for extended periods of time may affect device reliability.

DC and AC Operating Rage – 5V Operation

| | | AT6002-2/4 ⁽¹⁾ AT6003-2/4 ⁽¹⁾ AT6005-2/4 ⁽¹⁾ AT6010-2/4 ⁽¹⁾ Commercial ⁽¹⁾ | AT6002-2/4 ⁽¹⁾ AT6003-2/4 ⁽¹⁾ AT6005-2/4 AT6010-2/4 Industrial | AT6002-2/4 ⁽¹⁾ AT6003-2/4 ⁽¹⁾ AT6005-2/4 ⁽¹⁾ AT6010-2/4 ⁽¹⁾ Military ⁽¹⁾ |
|---|--------------------------|---|--|---|
| Operating Temperature (Case) | | 0°C - 70°C | -40°C - 85°C | -55°C - 125°C |
| V _{CC} Power Supply | | 5V ± 5% | 5V ± 10% | 5V ± 10% |
| Input Voltage Level | High (V _{IHT}) | 2.0V - V _{CC} | 2.0V - V _{CC} | 2.0V - V _{CC} |
| (TTL) | Low (V _{ILT}) | 0V - 0.8V | 0V - 0.8V | 0V - 0.8V |
| Input Voltage Level | High (V _{IHC}) | 70% - 100% V _{CC} | 70% - 100% V _{CC} | 70% - 100% V _{CC} |
| (CMOS) | Low (V _{ILC}) | 0 - 30% V _{CC} | 0 - 30% V _{CC} | 0 - 30% V _{CC} |
| Input Signal Transition Time (T _{IN}) | | 50 ns (max) | 50 ns (max) | 50 ns (max) |

DC and AC Operating Rage – 3.3V Operation(1)

| | | AT6002-2/4 ⁽¹⁾ , AT6003-2/4 ⁽¹⁾ AT6005-2/4 ⁽¹⁾ , AT6010-2/4 ⁽¹⁾ Commercial | |
|---|--------------------------|--|--|
| Operating Temperature (Cas | e) | 0°C - 70°C | |
| V _{CC} Power Supply | | 3.3V ± 5% | |
| Input Voltage Level | High (V _{IHT}) | 2.0V - V _{CC} | |
| (TTL) | Low (V _{ILT}) | 0V - 0.8V | |
| Input Voltage Level | High (V _{IHC}) | 70% - 100% V _{CC} | |
| (CMOS) | Low (V _{ILC}) | 0 - 30% V _{CC} | |
| Input Signal Transition Time (T _{IN}) | | 50 ns (max) | |



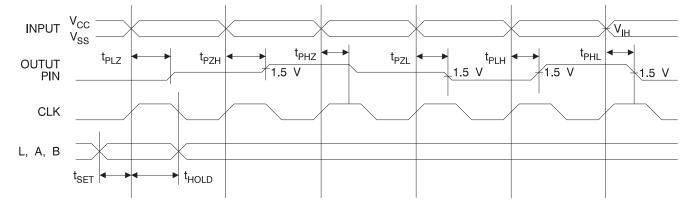
DC Characteristics – 3.3V Operation⁽²⁾

| Symbol | Parameter | Conditions | Conditions | | Max | Units |
|--------------------------------|---------------------------|--|--|---------------------|---------------------|-------|
| V | High level house Valtage | Camananaial | CMOS | 70% V _{CC} | V _{CC} | V |
| V _{IH} | High-level Input Voltage | Commercial | TTL | 2.0 | V _{CC} | V |
| V | Low lovel lanut Voltage | Commoraial | CMOS | 0 | 30% V _{CC} | V |
| V _{IL} | Low-level Input Voltage | Commercial | TTL | 0 | 0.8 | V |
| M | Link laval Output Valtage | Commonatel | I _{OH} = -2 mA, V _{CC} min | 2.4 | | V |
| V _{OH} | High-level Output Voltage | Commercial | I _{OH} = -6 mA, V _{CC} min | 2.0 | | V |
| V | Low-level Output Voltage | Commercial | $I_{OL} = +2 \text{ mA}, V_{CC} \text{ min}$ | | 0.4 | ٧ |
| V _{OL} | | | $I_{OL} = +6 \text{ mA}, V_{CC} \text{ min}$ | | 0.5 | V |
| | High-level Tristate | $V_{O} = V_{CC}$ (max) | | | 10 | |
| l _{OZH} | Output Leakage Current | | | | 10 | μΑ |
| | High-level Tristate | Without Pull-up, $V_O = V_{SS}$ | | -10 | | μΑ |
| I _{OZL} | Output Leakage Current | With Pull-up, $V_0 = V$ | With Pull-up, V _O = V _{SS} | | | μΑ |
| I _{IH} | High-level Input Current | V _{IN} = V _{CC} (max) | | | 10 | μΑ |
| I _{IL} | Law lawel lawyt Commant | Without Pull-up, V _{IN} = V _{SS} | | -10 | | μΑ |
| | Low-level Input Current | With Pull-up, V _{IN} = V _{SS} | | -500 | | μΑ |
| I _{cc} | Power Consumption | Without Internal Oscillator (Standby) | | | 200 | μΑ |
| C _{IN} ⁽¹⁾ | Input Capacitance | All Pins | | | 10 | pF |

Notes: 1. Parameter based on characterization and simulation; it is not tested in production.

2. Obsolete. Not recommended for new design.

Device Timing: During Operation





Ordering Information – AT6005

| Usable Gates | Speed Grade (ns) | Ordering Code | Package | Operation Range |
|-----------------|---------------------|---------------|---------|---------------------------|
| 15,000 | 2 | AT6005-2AU | 100A | 5V Industrial Temperature |
| | | | | (-40°C to 85°C) |
| 15,000 | 2 | AT6005-2AC | 100A | 5V Commercial |
| | | AT6005A-2AC | 144A | (0°C to 70°C) |
| | | AT6005-2JC | 84J | |
| | | AT6005-2QC | 132Q | |
| | | AT6005A-2QC | 208Q | |
| | | AT6005-2AI | 100A | Industrial |
| | | AT6005A-2AI | 144A | (-40°C to 85°C) |
| | | AT6005-2JI | 84J | |
| | | AT6005-2QI | 132Q | |
| | | AT6005A-2QI | 208Q | |
| 15,000 | 4 | AT6005-4AC | 100A | 5V Commercial |
| | | AT6005A-4AC | 144A | (0°C to 70°C) |
| | | AT6005-4JC | 84J | |
| | | AT6005-4QC | 132Q | |
| | | AT6005A-4QC | 208Q | |
| | | AT6005LV-4AC | 100A | 3.3V Commercial |
| | | AT6005ALV-4AC | 144A | (0°C to 70°C) |
| | | AT6005LV-4JC | 84J | |
| | | AT6005LV-4QC | 132Q | |
| | | AT6005ALV-4QC | 208Q | |
| | | AT6005-4AI | 100A | 5V Commercial |
| | | AT6005A-4AI | 144A | (-40°C to 85°C) |
| | | AT6005-4JI | 84J | |
| | | AT6005-4QI | 132Q | |
| | | AT6005A-4QI | 208Q | |

Note: 1 Obsolete. Package options are not recommended for new design.

| | Package Type |
|------|---|
| 84J | 84-lead, Plastic J-leaded Chip Carrier (PLCC) |
| 100A | 100-lead, Very Thin (1.0 mm) Plastic Gull-Wing Quad Flat Package (VQFP) |
| 132Q | 132-lead, Bumpered Plastic Gull-Wing Quad Flat Package (BQFP) |
| 144A | 144-lead, Thin (1.4 mm) Plastic Gull-Wing Quad Flat Package (TQFP) |
| 208Q | 208-lead, Plastic Gull-Wing Quad Flat Package (PQFP) |
| 240Q | 240-lead, Plastic Gull-Wing Quad Flat Package (PQFP) |

Ordering Information – AT6010

| Usable Gates | Speed Grade (ns) | Ordering Code | Package | Operation Range |
|-----------------|---------------------|---------------|---------|---------------------------|
| 30,000 | 2 | AT6010A-2AU | 144A | 5V Industrial Temperature |
| | | | | (-40°C to 85°C) |
| 30,000 | 2 | AT6010-2JC | 84J | 5V Commercial |
| | | AT6010A-2AC | 144A | (0°C to 70°C) |
| | | AT6010-2QC | 132Q | |
| | | AT6010A-2QC | 208Q | |
| | | AT6010H-2QC | 240Q | |
| | | AT6010-2JI | 84J | Industrial |
| | | AT6010A-2AI | 144A | (-40°C to 85°C) |
| | | AT6010-2QI | 132Q | |
| | | AT6010A-2QI | 208Q | |
| | | AT6010H-2QI | 240Q | |
| 30,000 | 4 | AT6010A-4AC | 144A | 5V Commercial |
| | | AT6010-4QC | 132Q | (0°C to 70°C) |
| | | AT6010-4JC | 84J | |
| | | AT6010A-4QC | 208Q | |
| | | AT6010H-4QC | 240Q | |
| | | AT6010ALV-4AC | 144A | 3.3V Commercial |
| | | AT6010LV-4QC | 132Q | (0°C to 70°C) |
| | | AT6010LV-4JC | 84J | |
| | | AT6010ALV-4QC | 208Q | |
| | | AT6010HLV-4QC | 240Q | |
| | | AT6010A-4AI | 144A | 5V Industrial |
| | | AT6010-4QI | 132Q | (-40°C to 85°C) |
| | | AT6010-4JI | 84J | |
| | | AT6010A-4QI | 208Q | |
| | | AT6010H-4QI | 240Q | |

Note: 1 Obsolete. Package options are not recommended for new design.

| | Package Type | | |
|------|---|--|--|
| 84J | 84-J 84-lead, Plastic J-leaded Chip Carrier (PLCC) | | |
| 100A | 100-lead, Very Thin (1.0 mm) Plastic Gull-Wing Quad Flat Package (VQFP) | | |
| 132Q | 132-lead, Bumpered Plastic Gull-Wing Quad Flat Package (BQFP) | | |
| 144A | 144-lead, Thin (1.4 mm) Plastic Gull-Wing Quad Flat Package (TQFP) | | |
| 208Q | 208-lead, Plastic Gull-Wing Quad Flat Package (PQFP) | | |
| 240Q | 240-lead, Plastic Gull-Wing Quad Flat Package (PQFP) | | |





Revision History

| Doc. No. | Date | Description |
|----------|---------|---|
| 0264G | 04/2015 | Obsoleted AT6002, AT6003, and all AT6K low voltage (LV) devices and the AT6005 and AT6010A lead based packages. Added lead free packages options for AT6005 and AT6010A devices. |
| 0264F | 10/2009 | |













Atmel Corporation

1600 Technology Drive, San Jose, CA 95110 USA

T: (+1)(408) 441.0311

F: (+1)(408) 436.4200

www.atmel.com

© 2015 Atmel Corporation. / Rev.: Atmel-0264G-FPGA-AT6000(LV)-Datasheet_042015.

Atmel®, Atmel logo and combinations thereof, Enabling Unlimited Possibilities, and others are registered trademarks or trademarks of Atmel Corporation in U.S. and other countries. Other terms and product names may be trademarks of others.

DISCLAIMER: The information in this document is provided in connection with Atmel products. No license, express or implied, by estoppel or otherwise, to any intellectual property right is granted by this document or in connection with the sale of Atmel products. EXCEPT AS SET FORTH IN THE ATMEL TERMS AND CONDITIONS OF SALES LOCATED ON THE ATMEL WEBSITE, ATMEL ASSUMES NO LIABILITY WHATSOEVER AND DISCLAIMS ANY EXPRESS, IMPLIED OR STATUTORY WARRANTY RELATING TO ITS PRODUCTS INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTY OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, OR NON-INFRINGEMENT. IN NO EVENT SHALL ATMEL BE LIABLE FOR ANY DIRECT, INDIRECT, CONSEQUENTIAL, PUNITIVE, SPECIAL OR INCIDENTAL DAMAGES (INCLUDING, WITHOUT LIMITATION, DAMAGES FOR LOSS AND PROFITS, BUSINESS INTERRUPTION, OR LOSS OF INFORMATION) ARISING OUT OF THE USE OR INABILITY TO USE THIS DOCUMENT, EVEN IF ATMEL HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES. Atmel makes no representations or warranties with respect to the accuracy or completeness of the contents of this document and reserves the right to make changes to specifications and products descriptions at any time without notice. Atmel does not make any commitment to update the information contained herein. Unless specifically provided otherwise, Atmel products are not suitable for, and shall not be used in, automotive applications. Atmel products are not intended, authorized, or warranted for use as components in applications intended to support or sustain life.

SAFETY-CRITICAL, MILITARY, AND AUTOMOTIVE APPLICATIONS DISCLAIMER: Atmel products are not designed for and will not be used in connection with any applications where the failure of such products would reasonably be expected to result in significant personal injury or death ("Safety-Critical Applications") without an Atmel officer's specific written consent. Safety-Critical Applications include, without limitation, life support devices and systems, equipment or systems for the operation of nuclear facilities and weapons systems. Atmel products are not designed nor intended for use in military or aerospace applications or environments unless specifically designated by Atmel as military-grade. Atmel products are not designed nor intended for use in automotive applications unless specifically designated by Atmel as automotive-grade.